

N-channel 80 V, 3.1 mOhm, Standard level MOSFET in LFPAK56

9 October 2023

Preliminary data sheet

#### 1. General description

Automotive qualified N-channel MOSFET using the latest Trench 14 low ohmic split-gate technology, for ultra-low  $R_{DSon}$  capability, housed in a LFPAK56 package. This product has been fully designed and qualified to meet AEC-Q101 requirements delivering high performance and endurance.

## 2. Features and benefits

- Fully automotive qualified to AEC-Q101:
  - 175 °C rating suitable for thermally demanding environments
- Trench 14 split-gate technology:
  - Reduced cell pitch enables enhanced power density and efficiency with lower R<sub>DSon</sub> in same footprint
  - Fast and efficient switching with high damping and low spiking
  - LFPAK Gull Wing leads:
    - High Board Level Reliability absorbing mechanical stress during thermal cycling, unlike traditional QFN packages
    - · Visual (AOI) soldering inspection, no need for expensive x-ray equipment
    - · Easy solder wetting for good mechanical solder joints
- LFPAK copper clip technology:
  - Improved reliability, with reduced R<sub>th</sub>, R<sub>DSon</sub> and package inductance
  - Increases maximum current capability and improved current spreading

#### 3. Applications

- 12 V, 24 V and 48 V automotive systems
- Motor, lighting and solenoid control
- Ultra high-performance power switching

## 4. Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
V <sub>DS</sub>	drain-source voltage	25 °C ≤ T <sub>j</sub> ≤ 175 °C		-	-	80	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 25 °C; <u>Fig. 2</u>	[1]	-	-	160	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; <u>Fig. 1</u>		-	-	300	W
Tj	junction temperature			-55	-	175	°C
Static characteristics							
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 25 °C; Fig. 10		1.7	2.5	3.1	mΩ

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Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Dynamic chara	cteristics					
Q <sub>G(tot)</sub>	total gate charge	$I_D = 25 \text{ A}; V_{DS} = 40 \text{ V}; V_{GS} = 10 \text{ V};$ Fig. 12; Fig. 13	36	72	108	nC

[1] 160 A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.

## 5. Pinning information

Table 2. Pinning information							
Pin	Symbol	Description	Simplified outline	Graphic symbol			
1	S	source	mb				
2	S	source		D			
3	S	source	a				
4	G	gate		G_(III ▲)			
mb	D	mounting base; connected to drain	L D D D 1 2 3 4 LFPAK56; Power- SO8 (SOT669)	mbb076 S			

## 6. Ordering information

Table 3. Ordering information					
Type number	Package				
	Name	Description	Version		
BUK7Y3R1-80M		plastic, single-ended surface-mounted package; 4 terminals	SOT669		

## 7. Marking

Table 4. Marking codes				
Type number	Marking code			
BUK7Y3R1-80M	73M180Y			

## 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).  $T_i = 25$  °C unless otherwise stated.

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	25 °C ≤ T <sub>j</sub> ≤ 175 °C		-	80	V
V <sub>GS</sub>	gate-source voltage			-20	20	V
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; <u>Fig. 1</u>		-	300	W
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 25 °C; <u>Fig. 2</u>	[1]	-	160	A
		V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 100 °C; <u>Fig. 2</u>		-	145	A
I <sub>DM</sub>	peak drain current	pulsed; $t_p \le 10 \ \mu s$ ; $T_{mb} = 25 \ ^{\circ}C$ ; Fig. 3		-	820	A
T <sub>stg</sub>	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C

BUK7Y3R1-80M

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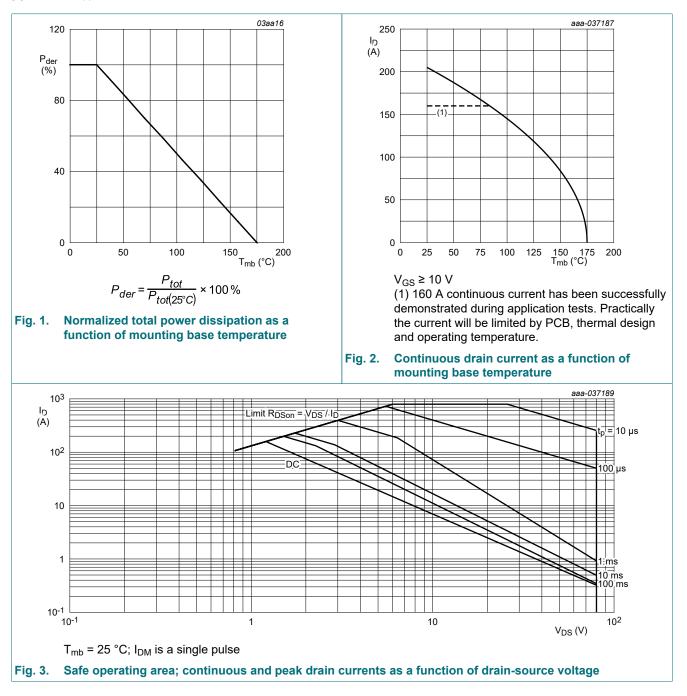
Symbol	Parameter	Conditions		Min	Мах	Unit
Source-drai	n diode					
Is	source current	T <sub>mb</sub> = 25 °C		-	160	А
I <sub>SM</sub>	peak source current	pulsed; t <sub>p</sub> ≤  10 µs; T <sub>mb</sub> = 25 °C		-	820	А
Avalanche r	ruggedness		-			
E <sub>DS(AL)S</sub>	non-repetitive drain- source avalanche energy	$\label{eq:ld} \begin{array}{l} I_{D} = 49 \; A; \; V_{sup} \leq \; 80 \; V; \; R_{GS} = 50 \; \Omega; \\ V_{GS} = \; 10 \; V; \; T_{j(init)} = 25 \; ^{\circ}C; \; unclamped; \\ \hline Fig. \; \frac{4}{3} \end{array}$	[2] [3] [4]	-	289	mJ

[1] 160 A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.

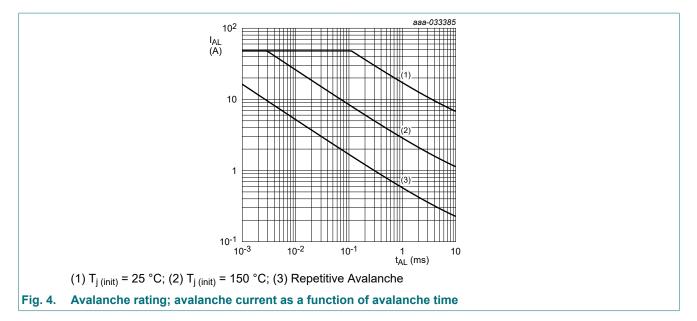
[2] Protected by 100% test

[3] Single-pulse avalanche rating limited by maximum junction temperature of 175 °C.

[4] Refer to application note AN10273 for further information.

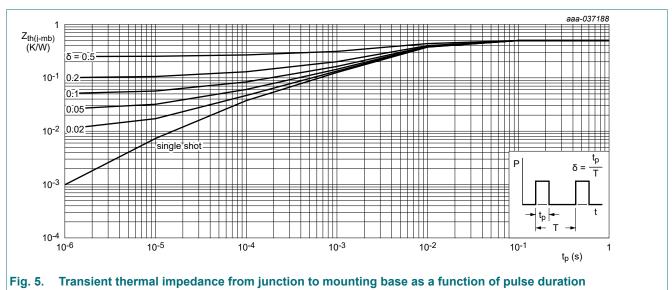


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## 9. Thermal characteristics

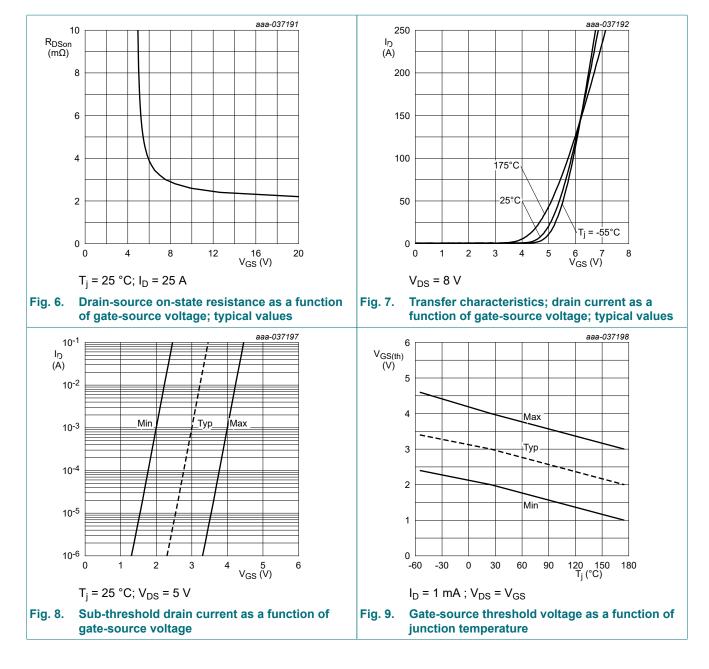
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-mb)</sub>	thermal resistance from junction to mounting base	<u>Fig. 5</u>	-	0.43	0.5	K/W



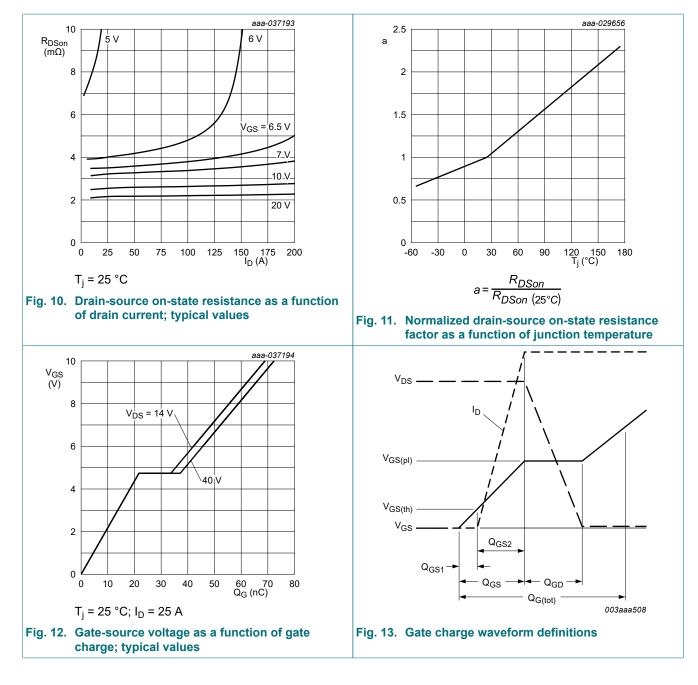
## **10. Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics					
V <sub>(BR)DSS</sub>	drain-source	I <sub>D</sub> = 250 μA; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	80	89	-	V
. ,	breakdown voltage	I <sub>D</sub> = 250 μA; V <sub>GS</sub> = 0 V; T <sub>j</sub> = -40 °C	-	86	-	V
		I <sub>D</sub> = 250 μA; V <sub>GS</sub> = 0 V; T <sub>j</sub> = -55 °C	72	85	-	V
V <sub>GS(th)</sub>	gate-source threshold	I <sub>D</sub> = 1 mA; V <sub>DS</sub> =V <sub>GS</sub> ; T <sub>j</sub> = 25 °C; <u>Fig. 8</u>	2	3	4	V
	voltage	I <sub>D</sub> = 1 mA; V <sub>DS</sub> =V <sub>GS</sub> ; T <sub>j</sub> = 175 °C; <u>Fig. 9</u>	1	2	-	V
		I <sub>D</sub> = 1 mA; V <sub>DS</sub> =V <sub>GS</sub> ; T <sub>j</sub> = -55 °C; <u>Fig. 9</u>	-	3.4	4.6	V
I <sub>DSS</sub>	drain leakage current	V <sub>DS</sub> = 80 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	0.07	1	μA
		V <sub>DS</sub> = 80 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 125 °C	-	2	100	μA
		V <sub>DS</sub> = 80 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 175 °C	-	50	500	μA
I <sub>GSS</sub>	gate leakage current	V <sub>GS</sub> = 20 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	2	100	nA
		V <sub>GS</sub> = -20 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	2	100	nA
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 25 °C; Fig. 10	1.7	2.5	3.1	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 105 °C; <u>Fig. 11</u>	2.6	4	5	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 125 °C; Fig. 11	2.9	4.5	5.5	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 175 °C; Fig. 11	3.7	5.8	7.1	mΩ
R <sub>G</sub>	gate resistance	f = 1 MHz; T <sub>j</sub> = 25 °C	0.35	0.7	1.4	Ω
Dynamic ch	naracteristics					
Q <sub>G(tot)</sub>	total gate charge	I <sub>D</sub> = 25 A; V <sub>DS</sub> = 40 V; V <sub>GS</sub> = 10 V;	36	72	108	nC
Q <sub>GS</sub>	gate-source charge	Fig. 12; Fig. 13	9	21.7	35	nC
Q <sub>GD</sub>	gate-drain charge		5	15.5	34	nC
C <sub>iss</sub>	input capacitance	V <sub>DS</sub> = 40 V; V <sub>GS</sub> = 0 V; f = 1 MHz;	3000	4990	6986	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C; <u>Fig. 14</u>	447	1118	1790	pF
C <sub>rss</sub>	reverse transfer capacitance	-	5	53	154	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS}$ = 40 V; R <sub>L</sub> = 1.6 Ω; V <sub>GS</sub> = 10 V;	-	20	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 5 \Omega$	-	19	-	ns
t <sub>d(off)</sub>	turn-off delay time		-	38	-	ns
t <sub>f</sub>	fall time		-	22	-	ns
Source-dra	in diode	· · ·	I			
V <sub>SD</sub>	source-drain voltage	I <sub>S</sub> = 25 A; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C; <u>Fig. 15</u>	-	0.81	1	V
t <sub>rr</sub>	reverse recovery time	I <sub>S</sub> = 25 A; dI <sub>S</sub> /dt = -100 A/µs; V <sub>GS</sub> = 0 V;	-	38	-	ns
	recovered charge	V <sub>DS</sub> = 40 V; <u>Fig. 16</u>		36		nC

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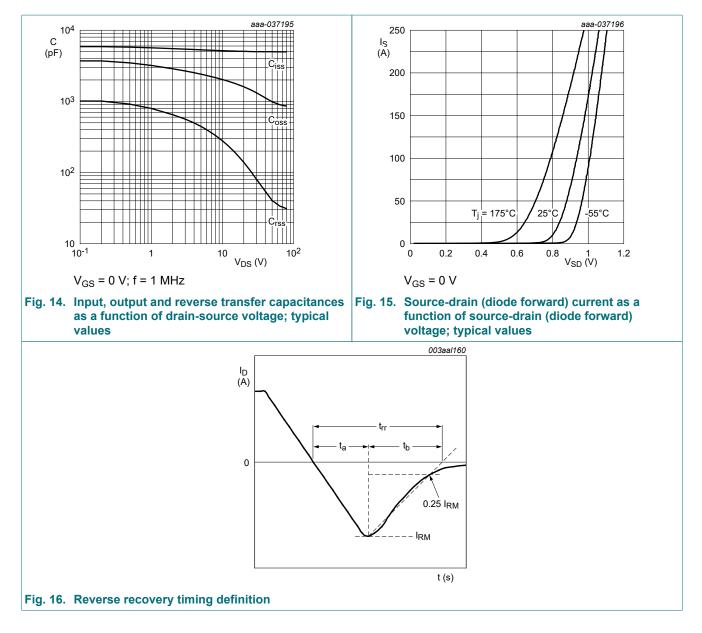


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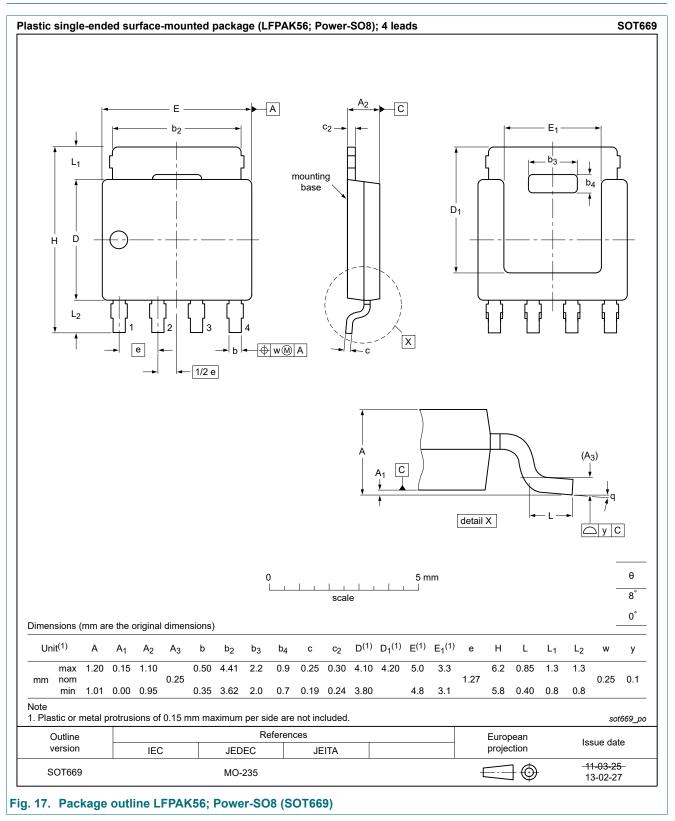
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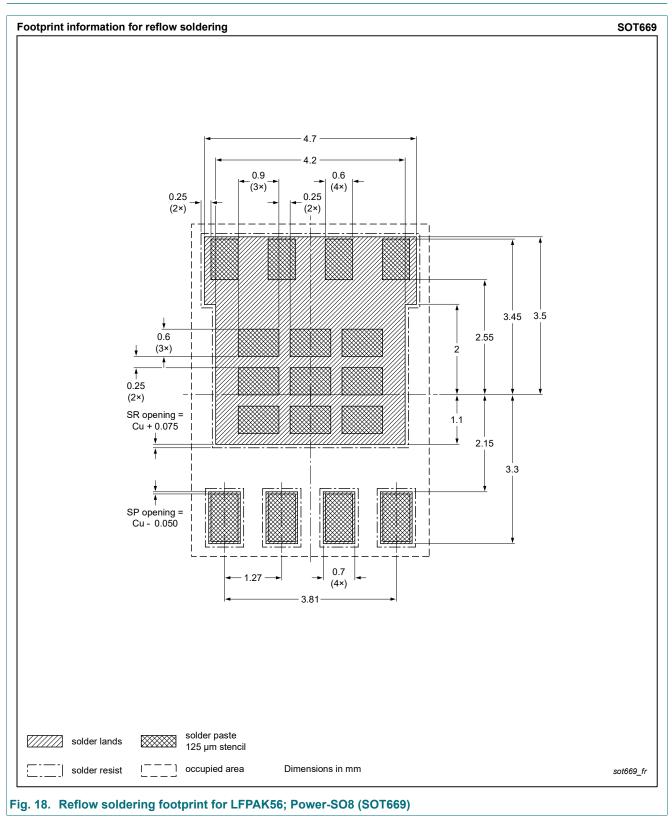


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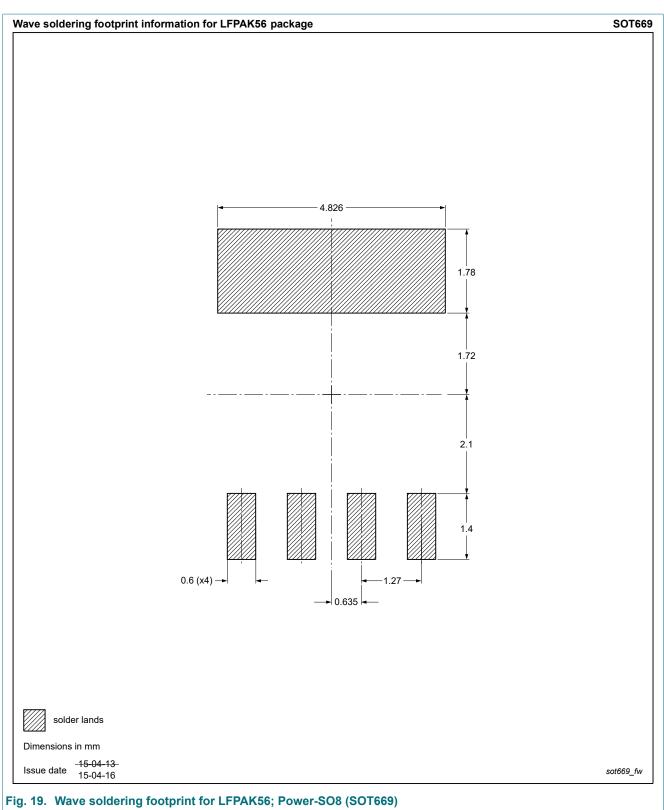
## **11. Package outline**



## 12. Soldering







## 13. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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 Please consult the most recently issued document before initiating or completing a design.

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